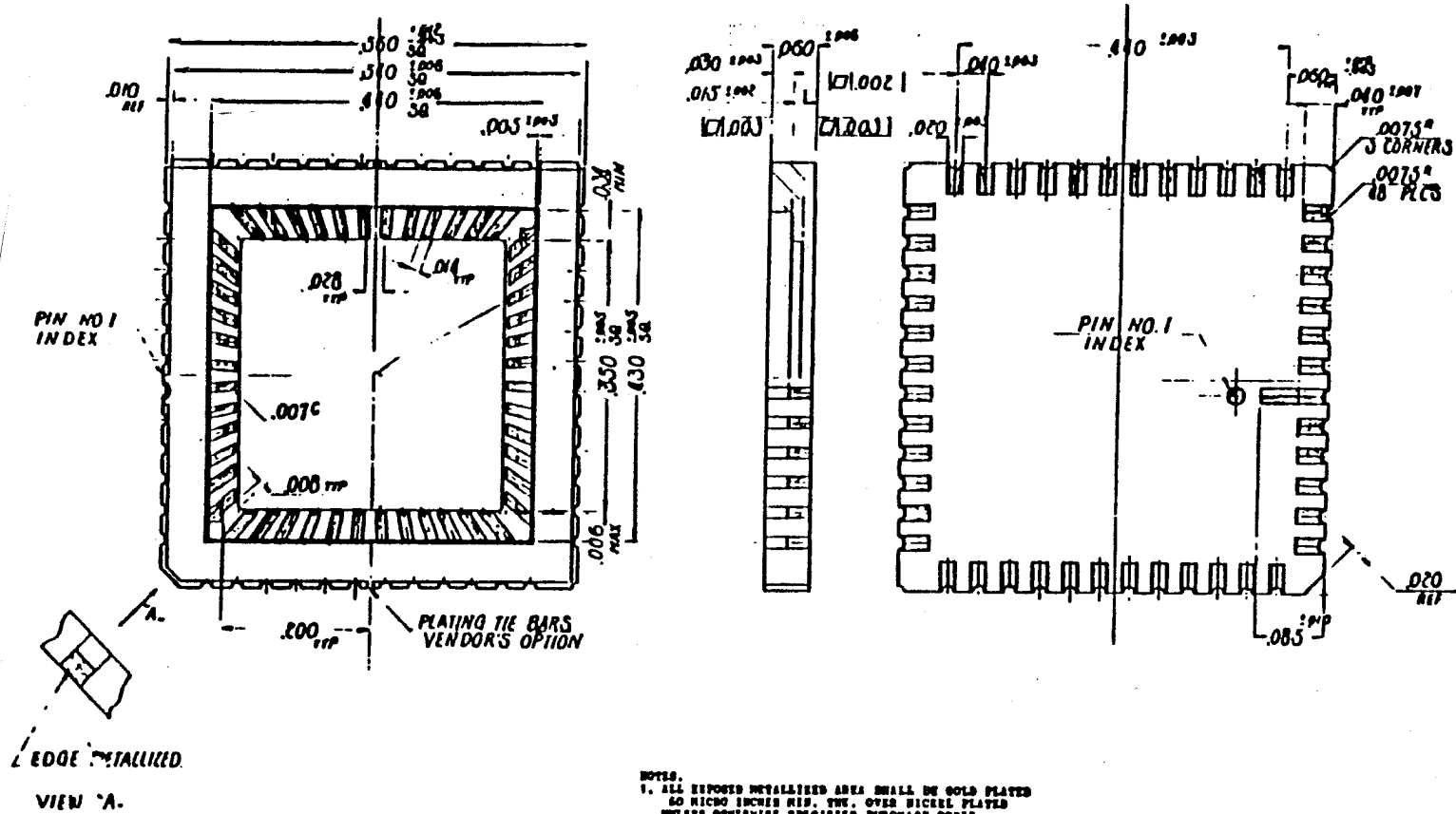


SSM P/N LCC04805



- NOTES:
1. ALL EXPOSED METALLIZED AREA SHALL BE GOLD PLATED 50 MICRO INCHES THK. OVER NICKEL PLATED UNLESS OTHERWISE SPECIFIED PURCHASE ORDER.
 2. PLATNESS PERTAINS TO METALLIZED PAD ONLY.
 3. LEAD TO LEAD LEAKAGE MUST NOT EXCEED 5 NANO AMPS AT 100 V D.C.
 4. SEAL AREA TO BE CONNECTED PIN NO. 0.
 5. DIE ATTACH PAD TO BE CONNECTED PIN NO. 0.

NAME 88 LEAD CHIP CARRIER		TOLERANCES: UNLESS OTHERWISE SPECIFIED		RC-ARCODE	
SCALE 10/1	MATERIAL KYOCERA A410	FINISH 17	PLI :003	DATE 7.11	APPROVED 79.9.10
KYOTO CERAMIC CO., LTD. 5181R				PR-92301-A	



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